

ITEM	DESC.	Q'TY	MATERIALS	TDEATMENT	REMARK
I I □IVI	DESC.	UII	MATERIALS	TREATMENT	KEWAKK
1.	STEM	1	HIGH-TEMP THERMOPLASTIC NYLON UL 94V-0	-	-
2.	COVER 1		Without Ground Pin:STAINLESS STEEL With Ground Pin:NICKEL SILVER	NONE	-
3.	CONTACT	1	STAINLESS STEEL	WITH SILVER CLADDING	-
4.	TERMINAL	1	BRASS	WITH SILVER PLATING	-
5.	BASE	1	HIGH – TEMP THERMOPLASTIC LCP	MOLDED BLACK	-
			Package Style:  = Bag  T/R = Tape & Reel  B = Tube  V = Lead Free Solderate  Color Of Stem For Oper  K = BLACK , 100g  N = BROWN , 160g  R = RED , 260g  N/Y=YELLOW,160g  Height: 0=2.0mm  1 = 2.5mm  2 = 3.1mm  3 = 3.5mm  4=5.25mm  Base Materials:  L = LCP	rating Force:  R/K= BLACK,260g	0 2 3
			P=With Post(S.M.T Onl Termination Type : M =Gull wing Terminal F =Flat Terminal	у)	
			Z=Terminal Pitch 4.5 mi	m	
			Prod. Series :		
-	新增高度 5.25mm 產品	R HH 羔	□=Without Ground Pin G = With Ground Pin		
2		『明義 『明義	TITLE: TACTILE SWITC	H APPD.:	
-		印明義	WITH WASHABLE TYP	· ·	
A REV.	DWG. REL.	邛明義 APPD	PRROD. NO. : DTS_ZL -6 FILE NO. : E-V-CT29	□-V-□ PR. : F REV :E SHE	PAGGY EET: 1 of 1

	FILE No.	:	E-/	V-AT	20
DTS ZM -6 -V SPECIFICATION	REV.	:		С	
	Page	:	1	/	5

## 1. Style

This specification describes "TACTILE SWITCH", mainly used as signal switch of electric devices, with the general requirements of mechanical and electrical characteristic.

1.1 Operating Temperature Range: -25°C+70°C

1.2 Storage Temperature Range : -30°C +80°C

1.3 The shelf life of product is within 6 months.

2. Current Range: 50mA, 12 VDC

3. Type of Actuation: Tactile feedback

4. Test Sequence:

	ITEM	DESCRIPTION	TEST CONDITIONS	REQUIREMENTS
APPEARANCE	1	Visual Examination	By visual examination check without any out pressure & testing.	There shall be no defects that affect the serviceability of the product.
	2	Contact Resistance	Applying a static load 1.5~2 times the operating force to the center made with a 1 kHz small current contact resistance meter.	100mΩ Max.
ELECTRIC PERFORMANCE	3	Insulation Resistance	Measurements shall be made following application of 500 V DC potential across terminals and cover for 1 minute ±5 seconds.	100MΩ Min.
PERFO	4	Dielectric Withstanding Voltage	250 V AC(50Hz or 60Hz) shall be applied across terminals and cover for 1 minute	There shall be no breakdown or flashover.
SC	5	Capacitance	1 MHz ±10kHz	5 pF Max.
ELECTF	6.	Bounce	3 to 4 operations at a rate of 1 cycles per second  Switch Synchroscope  5V DC 5ΚΩ	5 m seconds Max.

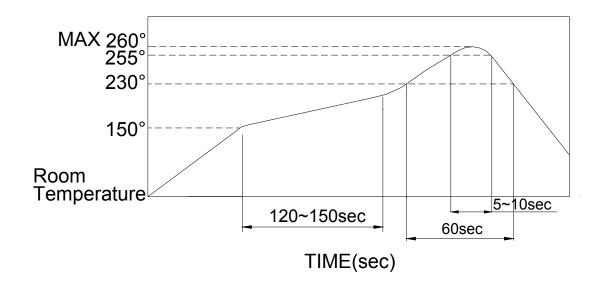
Ĺ	DTS_ZM6V SPECIFICATION   FILE No.   E-V-AT2   REV.   C   Page   E   2 /						5		
	7.	Operating Force	Applied in the direction of operation.	O F	100±50g (.98±.49N )		N±.4		N±.4
	Placing the switch such that the direction of switch operation is vertical and then gradually increasing the load applied to the stem, the stroke distance for the stem to come to a stop shall be measured.				25 +0.2/-0.	<b>1</b> mm			
MECHANICAL PERFORMANCE	9.	Stop Strength	Placing the switch such that the direction of switch operation is vertical, a static load of 3 kgf (29.4N) shall be applied in the direction of stem operation for a period of 15 seconds	1.As shown in item 4~7  2.Contact Resistance: 200mΩ Max  3.Insulation Resistance: 10MΩ Min					
MECHANICA	10.	Solder Heat Resistance	■ SMT Type 5 of 5 DTS☐ ZM-6 \ DTS☐ZML-6 Series	1.Shall be free from pronounced backlash and falling-off or breakage terminals 2.As shown in item 4 \ 5 3.Contact Resistance: 200mΩ Max 4.Insulation Resistance: 10MΩ min			ced		
	11.	Vibration	Shall be vibrated in accordance with Method 201A of MIL-STD-202F 1.Frequency: 10-55-10Hz in 1-min/cycle. 2.Direction: 3 vertical directions including the directions of operation 3.Test time: 2 hours each direction. 4.Swing distance=1.5mm	2.0 2 3.1	Contact Re 200mΩ Ma	wn in item 4~7 t Resistance: Max on Resistance:			

DTS  ZM  -6  -V SPECIFICATION			FILE No. REV. Page	: E-V-AT20 : C : 3 / 5		
MECHANICAL PERFORMANCE	12	Shock	Shall be shocked in accordance with Method 213B condition A of MIL-STD-202F 1.Acceleration; 50G 2.Action time:11±1m seconds 3.Testing Direction: 6 sides 4.Test Cycle: 3 times in each direction	<ul><li>1.As shown in item 4~7</li><li>2.Contact Resistance: 200mΩ Max</li><li>3.Insulation Resistance: 10MΩ Min</li></ul>		
DURABILITY	13	Operating Life	Measurements shall be made following the test forth below:  1.5 mA,5 VDC resistive load  2.Applying a static load the operating force to the center of the stem in the direction of operation  Static Load = OF Max.  3.Cycle of Operation:  1,000,000 cycle's Min.  For 100gf \ 160gf  100,000 cycle's Min.  For 260gf	<ul> <li>1.As shown in</li> <li>2.Operating force.</li> <li>3.Contact Res</li> <li>10Ω Max</li> <li>4.Insulation Res</li> <li>10MΩ Min</li> <li>5.Bounce:</li> <li>10 m second</li> </ul>	rce: ±50% of istance:	
	14	Resistance Low Temperature	Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before the measurements are made:  1.Temperature:-25±3°C  2.Time:96 hours	<ul><li>1.As shown in</li><li>2.Contact Res</li><li>200mΩ Max</li><li>3.Insulation Re</li><li>10MΩ Min</li></ul>	istance:	
WEATHER-PROOF	15	Resistance High Temperature	Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before the measurements are made:  1.Temperature:80±2°C  2.Time:96 hours	Dit	ito	
W	าก	Resistance Humidity	Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before the measurements are made:  1.Temperature:40±2°C  2.Relative Humidity:90~95%  3.Time:96 hours	Dit	ito	

	FILE No.	:	E-/	V-AT	20
DTS ZM -6 U-V SPECIFICATION	REV.	:		С	
	Page	:	4	/	5

## 5. SOLDERING CONDITIONS:

■ Condition for Reflow Soldering –DTS ZM-6 DTS ZML-6Series



- The condition mentioned above is the temperature on the Cu foil of the PCB surface. There are cases where board's temperature greatly differs from switch's surface be used not to allow switch's surface temperature to exceed 260°C.
- Manual Soldering

Soldering Temperature	Max. 350°C
Continuous Soldering Time	Max. 5 seconds

## ■ Precautions in Handling

- 1. Care should be exercised so that flux from the upper part of the printed circuit board does not adhere to the switch.
- 2. Except for washable type do not wash the switch body.

■ Notes on storage conditions:			5	 5
Do not store in the following environment or it may effect or				
Do not store in the following environment or it may affect pr solderbility:	roduct's function	ar	ıd	
1. temperature of -10 (max) ~ +40 (min) °C & humidit	ty at 85% (min)			
2. environment with corrosive gas				
3. storage over 6 months				
4. place of direct sunlight				
Store with proper packaging conditions and to avoid loading	g heavy force			
We suggest to use the products within 3 months or at least	6 months.			
After opening the package, the rest products must be stored moisture-proof & airtight environment.	d in the appropr	iate	Э	